



EXHIBITION & SPONSORSHIP - REPLY SLIP

We are pleased to offer the following Exhibitor/Sponsorship Program to IEEE APCAP 2018 and will abide by the rules of this sponsorship set by the Conference Organizing Committee.

CATEGORY	SUMMARY OF BENEFITS	CHOICE
Platinum (USD6,000)	One large size exhibition booth. Two complimentary registrations including banquet dinner; One full-page color advertisement in Final Program; Company logo display on Conference Banner; Web link; Promotional Inserts.	<input type="checkbox"/>
Gold (USD4,000)	One medium size exhibition booth; Two complimentary registrations including banquet dinner; One full-page color advertisement in Final Program; Company logo display on Conference Banner; Web link; Promotional Inserts.	<input type="checkbox"/>
Silver (USD3,000)	One medium size exhibition booth; One complimentary registration including banquet dinner; One full-page b/w advertisement in Final Program; Web link; Promotional Inserts.	<input type="checkbox"/>
Bronze (USD2,000)	One small size exhibition booth; One full-page b/w advertisement in Final Program; Web link; Promotional Inserts.	<input type="checkbox"/>
Others	Please suggest and specify.	<input type="checkbox"/>

Date: _____

Company: _____

Address: _____

Contact Name: _____ Designation: _____

Telephone: _____ Mobile Phone: _____ Fax: _____

Email: _____

Signature: _____ Company Stamp: _____

Enclosed please find the Cheque No. _____ for the amount USD _____ made payable to

“IEEE APCAP 2018”. Kindly send the cheque to:

Dr. Terence SEE, Logistics & Exhibition Chair
 Institute for Infocomm Research
 1 Fusionopolis Way, #21-01 Connexis (South Tower), Singapore 138632
 Telephone: +65-6408 2377
 Fax: +65-6776 1378
 Email: spsee@i2r.a-star.edu.sg

Note: Our Exhibition/Sponsorship Program is flexible and open to alternative suggestions for participation. All sponsorship amounts are inclusive of local taxes.